



**Part Number :** [791077058](#)

**Product Description :** 2.00mm Pitch Milli-Grid Receptacle, Vertical, Through Hole, Dual Row, 3.00mm Tail Length, 0.76µm Gold (Au) Selective Plating, 18 Circuits, Lead-Free

**Series Number :** 79107

**Status :** Active

**Product Category :** PCB Headers and Receptacles

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## Documents and Resources

### Drawings

[791077058 sd.pdf](#)

[PK-70873-0180-001.pdf](#)

### 3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)

[Symbol and Footprint \(Multi-Format\)](#)

### Specifications


[503940001-AS-000.pdf](#)

[PS-79107-001.pdf](#)

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## Product Environment Compliance

### Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)6375-DC (05 Nov 2025) SCIP:9b57ad9e-307b-418e-a95f-35bbea3c472a

EU RoHS	Compliant per EU 2015/863
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### Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

### Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

### Substances of Interest

- PFAS

### EU RoHS Certificate of Compliance

### Additional Product Compliance Information

## Part Details

### General

Status	Active
Category	PCB Headers and Receptacles
Series	79107
Description	2.00mm Pitch Milli-Grid Receptacle, Vertical, Through Hole, Dual Row, 3.00mm Tail Length, 0.76µm Gold (Au) Selective Plating, 18 Circuits, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Name	Milli-Grid
UPC	822348474776

### Agency

CSA	LR19980
UL	E29179

### Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	125V

## Physical

Circuits (Loaded)	18
Circuits (maximum)	18
Color - Resin	Black
Durability (mating cycles max)	50
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Lock to Mating Part	None
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.528/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	3.00mm
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.762µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Polarized to PCB	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

## Solder Process Data

Max-Duration	10
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Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	260

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## Mates With / Use With

### Mates with Part(s)

Description	Part Number
Milli-Grid Vertical Through Hole Headers	<u>87758</u>
Milli-Grid Vertical Surface Mount Headers	<u>87759</u>
Milli-Grid Right-Angle Through Hole Headers	<u>87760</u>
Milli-Grid Vertical, Dual Row, Through Hole Headers	<u>87831</u>
Milli-Grid Vertical, Dual Row, Surface Mount Headers	<u>87832</u>
Milli-Grid Vertical, Dual Row, Through Hole Headers	<u>151117</u>
Milli-Grid Vertical, Dual Row, Surface Mount Headers	<u>151118</u>
Milli-Grid Right-Angle, Dual Row, Through Hole Headers	<u>151119</u>
Milli-Grid Right-Angle, Dual Row, Surface Mount Headers	<u>151120</u>

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This document was generated on Dec 28, 2025